












Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0.010mm	3.5
4		Top Layer 1	Copper	0.035mm	
5		Dielectric 2	PP-006	0.320mm	4.1
6		GroundPlane	Copper	0.035mm	
7		Dielectric 1	Core-040	0.787mm	4.6
8		VccPlane	Copper	0.035mm	
9		Dielectric 3	PP-006	0.320mm	4.1
10		Bottom Layer 1	Copper	0.035mm	
11		Bottom Solder	Solder Resist	0.010mm	3.5
12		Bottom Overlay			
13		Bottom Paste			
	Height : 1.588mm				